PR01/02/03

FEATURES

- · High power in small packages
- Different lead materials for different applications
- · Defined interruption behaviour.

APPLICATIONS

All general purpose power applications.

DESCRIPTION

A homogeneous film of metal alloy is deposited on a high grade ceramic body. After a helical groove has been cut in the resistive layer, tinned connecting wires of electrolytic copper or copper-clad iron are welded to the end-caps. The resistors are coated with a red, nonflammable lacquer which provides electrical, mechanical and

climatic protection. This coating is not resistant to aggressive fluxes. The encapsulation is resistant to all cleaning solvents in accordance with "MIL-STD-202E, method 215", and "IEC 60068-2-45".

QUICK REFERENCE DATA

		VALUE							
DESCRIPTION	PD04	PRO	2	PRO	3				
	PR01	Cu-lead	FeCu-lead	Cu-lead	FeCu-lead				
Resistance range	$0.22~\Omega$ to $1~M\Omega$	$0.33~\Omega$ to $1~M\Omega$	1 Ω to 1 MΩ	$0.68~\Omega$ to $1~M\Omega$	1 Ω to 1 MΩ				
Resistance tolerance and series	<u>+</u>	1% (E96 series); ±5	% (E24 series);	see notes 1 and 2					
Maximum dissipation at T _{amb} = 70 °C:									
R < 1 Ω	0.6 W	1.2 W	-	1.6 W	_				
1 Ω ≤ R	1 W	2 W	1.3 W	3 W	2.5 W				
Thermal resistance (Rth)	135 K/W	75 K/W	115 K/W	60 K/W	75 K/W				
Temperature coefficient		<u> </u>	$\pm 250 \times 10^{-6}$ /K		·				
Maximum permissible voltage (DC or RMS)	350 V	500	V	750	V				
Basic specifications	Ţ	IEC 60	115-1 and 601	15-4					
Climatic category (IEC 60068)			55/155/56	·					
Stability after:									
load	Δ R/R max.: \pm 5% + 0.1 Ω								
climatic tests		Δ R/R max.: $\pm 3\% + 0.1 \Omega$							
soldering		ΔR/R r	nax.: ±1% + 0.0)5 Ω					

Notes

- 1. 1% tolerance is available for R_n-range from 1R upwards.
- 2. 2% tolerance is available on request for R_n-range from 1R upwards.

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ORDERING INFORMATION

 Table 1
 Ordering code indicating resistor type and packaging

					ORDERIN	G CODE 2	23	BANDOLI	ER)		
				AMMOPACK						REEL	
TYPE	LEAD Ø	TOL	DADIAL TARED				STR	AIGHT LE	ADS		
	(mm)	(%)	KADIAI	RADIAL TAPED		52 mm	63 mm	73 mm	80 m m	73 mm	52 mm
			4000 units	3000 units	5 000 units	1 000 units	500 units	1 000 units	500 units	5 000 units	5 000 units
PR01	Cu 0.6	1	_	-	22 196 1	-	_	_			_
FROI	Cu 0.0	5	06 197 03	-	22 193 14	_	-	22 193 13	~	22 193 23	06 197 23
	Cu 0.8	1	_	_	_	22 197 1	_	-	-		_
PR02	Cu 0,0	5	_	06 198 03	_	06 198 53	_	22 194 13	-	_	06 198 23
	FeCu 0.6	5	_	_		22 194 54	_	22 194 53	-	_	_
	Cu 0.8	5	_	_	_	_	22 195 14	-	22 195 13	_	_
PR03	Cu v.o	1	_	_	_	-	_	_	06 193 5	_	-
	FeCu 0.6	5	_	_	_	_	22 195 54	_	22 195 53	_	_

 Table 2
 Ordering code indicating resistor type and packaging

				ORDERING CODE 23 (LOOSE IN BOX)								
	LEAD	TOL	CROPPED AND FORMED(1)		DOUBLE KINK							
TYPE	(mm)	(%)	h ⁽²⁾ = 8 mm	h ⁽²⁾ = 15 mm	LARGE	PITCH ⁽¹⁾	SMALL	PITCH				
(******)				5000 units	1 000 units 500 units		1000 units	500 units				
DD01	Cu 0.6	5	22 193 33 (3)	_	22 193 03	_	-	_				
PR01	FeCu 0.6	5	_	_	22 193 43	_	22 193 53	-				
	Cu 0.8	5	22 194 33	22 194 43	-		-	_				
PR02	FeCu 0.6	5	22 194 73 ⁽³⁾	-	22 194 83	-	-					
	FeCu 0.8	5			-		22 194 63	_				
	Cu 0.8	5	22 195 33	22 195 43	~	_	_	_				
PR03	FeCu 0.6	5	22 195 73 ⁽³⁾	_	-	22 195 83	_	_				
	FeCu 0.8	5	-		-	-	_	22 195 63				

Notes

- 1. Maintenance types, not for new designs.
- 2. h = mounted height above PCB (see Fig.41).
- 3. Type can be replaced by double kink, large pitch.

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Ordering code (12NC)

- The resistors have a 12-digit ordering code starting with 23.
- The first 7 digits indicate the resistor type and packaging;
 see Tables 1 and 2.
- The remaining 3 digits indicate the resistance value:
 - The first 2 digits indicate the resistance value.
 - The last digit indicates the resistance decade in accordance with Table 3.

Table 3 Last digit of 12NC

RESISTANCE DECADE	LAST DIGIT
0.22 to $0.91~\Omega$	7
1 to 9.76 Ω	8
10 to 97.6 Ω	9
100 to 976 Ω	1
1 to 9.76 kΩ	2
10 to 97.6 kΩ	3
100 to 976 kΩ	4
1 ΜΩ	5

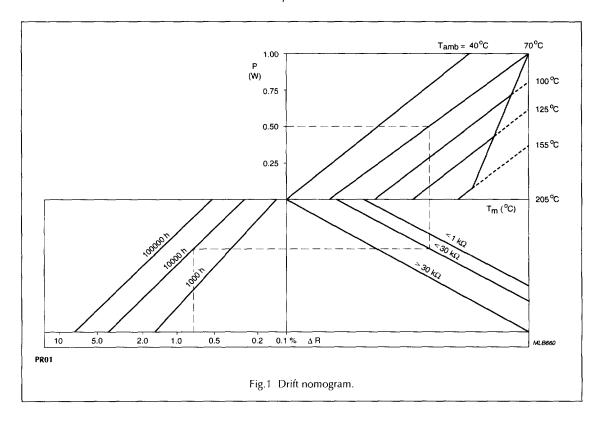
Ordering example

The ordering code for resistor type PR02 with Cu leads and a value of 750 Ω , supplied on a bandolier of 1000 units in ammopack, is: 2322 194 13751.

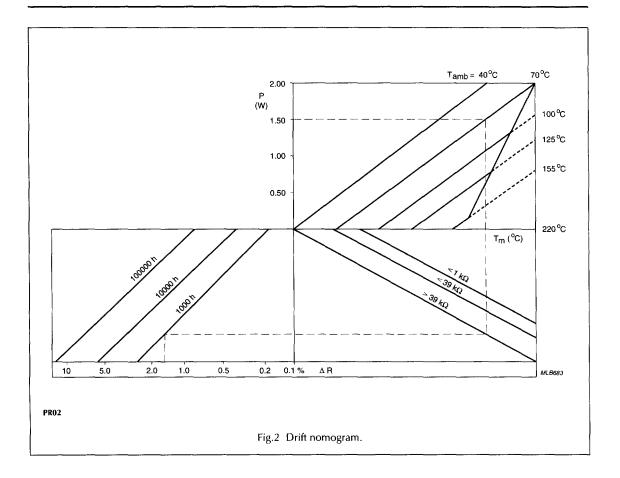
FUNCTIONAL DESCRIPTION

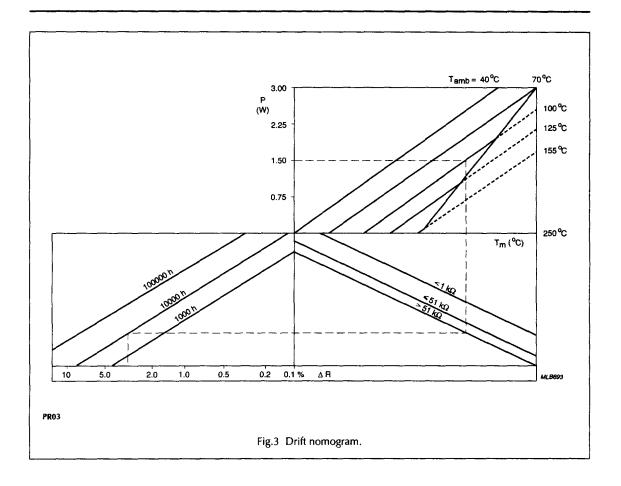
Product characterization

Standard values of nominal resistance are taken from the E24 series for resistors with a tolerance of $\pm 5\%$. The values of the E24 series are in accordance with "IEC publication 60063".



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Limiting values

TYPE	LEAD MATERIAL	RANGE	LIMITING VOLTAGE ⁽¹⁾ (V)	LIMITING POWER (W)
DD01	C	R < 1 Ω	250	0.6
PR01	Cu	1 Ω ≤ R	350	1.0
	C	R < 1 Ω		1.2
PR02	Cu	1 Ω ≤ R	500	2.0
	FeCu	1 Ω ≤ R		1.3
	C	R < 1 Ω		1.6
PR03	Cu	1 Ω ≤ R	750	3.0
	FeCu	1 Ω ≤ R		2.5

Note

1. The maximum voltage that may be continuously applied to the resistor element, see "IEC publication 60115-1".

The maximum permissible hot-spot temperature is 205 °C for PR01, 220 °C for PR02 and 250 °C for PR03.

DERATING

The power that the resistor can dissipate depends on the operating temperature; see Fig.4.

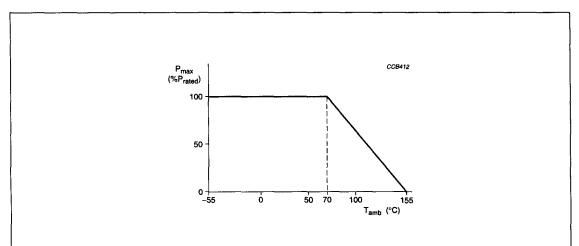
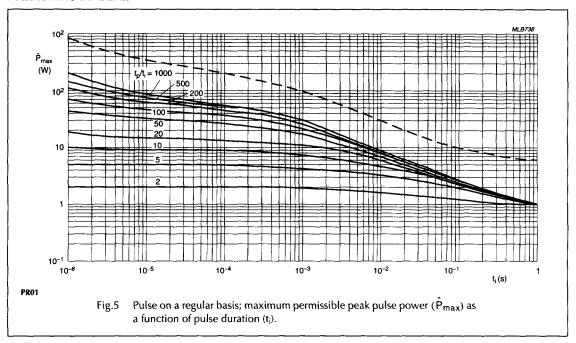
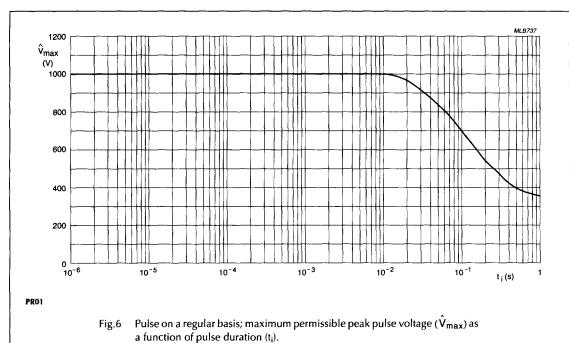


Fig. 4 Maximum dissipation (P_{max}) in percentage of rated power as a function of the ambient temperature (T_{amb}).

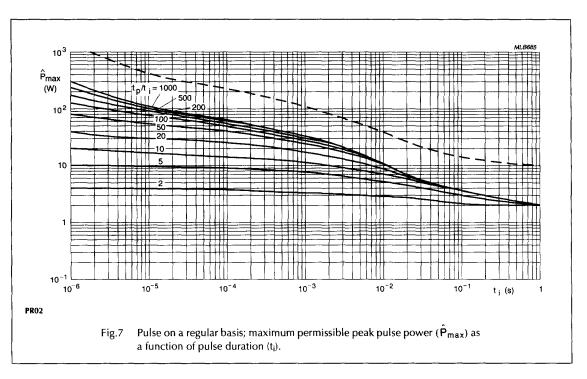
PR01/02/03

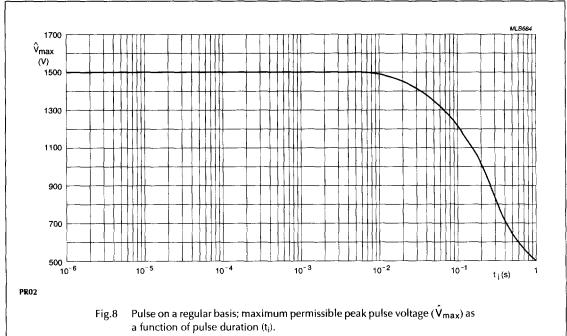
PULSE LOADING CAPABILITIES



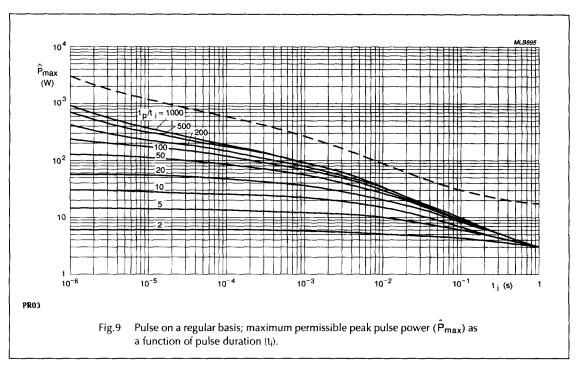


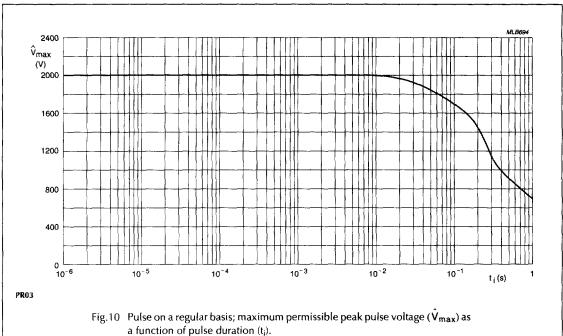
272





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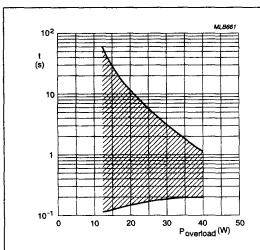


Product specification

Professional power metal film resistors

PR01/02/03

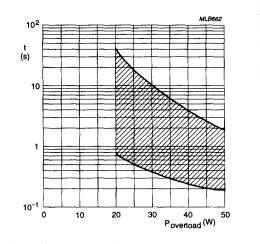
INTERRUPTION CHARACTERISTICS



The graph is based on measured data under constant voltage conditions; these data may deviate according to the application.

PRO

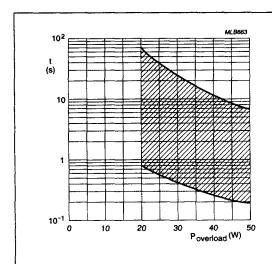
Fig.11 Time to interruption as a function of overload power for range: $0R22 \le R_n < 1R$.



The graph is based on measured data under constant voltage conditions; these data may deviate according to the application.

PRO!

Fig.12 Time to interruption as a function of overload power for range: $1R \le R_n \le 15R$.

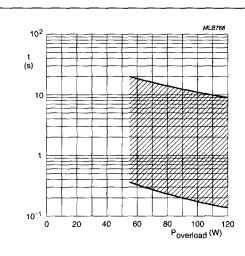


The graph is based on measured data under constant voltage conditions; these data may deviate according to the application.

PRO

Fig. 13 Time to interruption as a function of overload power for range: $16R \le R_n \le 560R$.

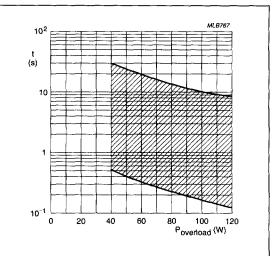
PR01/02/03



The graph is based on measured data under constant voltage conditions; these data may deviate according to the application.

PR02

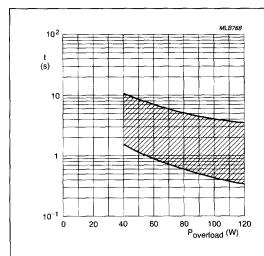
Fig. 14 Time to interruption as a function of overload power for range: $0.33R \le R_n < 5R$.



The graph is based on measured data under constant voltage conditions; these data may deviate according to the application.

PR02

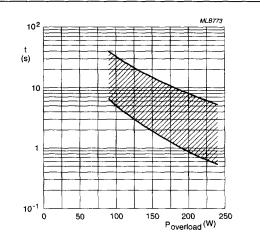
Fig.15 Time to interruption as a function of overload power for range: $5R \le R_n < 68R$.



The graph is based on measured data under constant voltage conditions; these data may deviate according to the application.

PR02

Fig.16 Time to interruption as a function of overload power for range: $68R \le R_p \le 560R$.



The graph is based on measured data under constant voltage conditions; these data may deviate according to the application.

PR03

Fig.17 Time to interruption as a function of overload power for range: $0.68R \le R_n \le 560R$.

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Application information

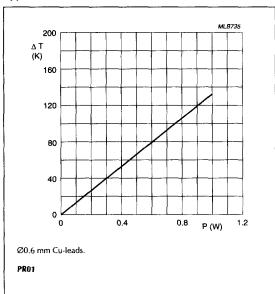


Fig.18 Hot-spot temperature rise (ΔT) as a function of dissipated power.

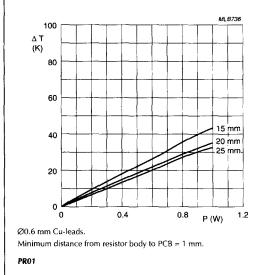
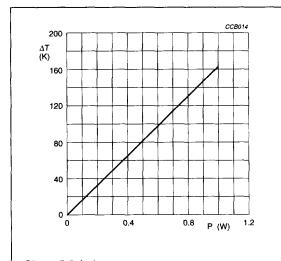


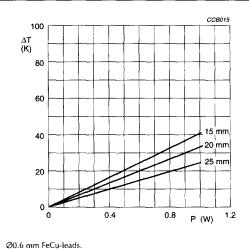
Fig.19 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø0.6 mm FeCu-leads.

PR01

Fig.20 Hot-spot temperature rise (ΔT) as a function of dissipated power.



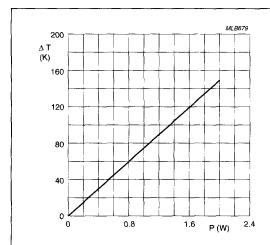
Minimum distance from resistor body to PCB = 1 mm.

PR01

Fig.21 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

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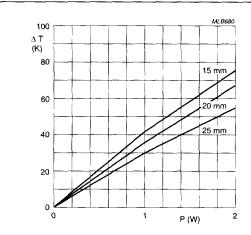
PR01/02/03



Ø0.8 mm Cu-leads.

PR02

Fig.22 Hot-spot temperature rise (ΔT) as a function of dissipated power.

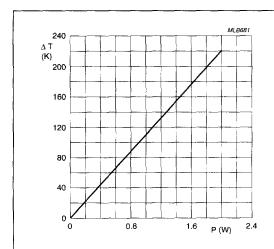


Ø0.8 mm Cu-leads.

Minimum distance from resistor body to PCB = 1 mm.

PR02

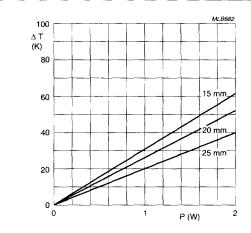
Fig.23 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø0.6 mm FeCu-leads.

PR02

Fig.24 Hot-spot temperature rise (ΔT) as a function of dissipated power.



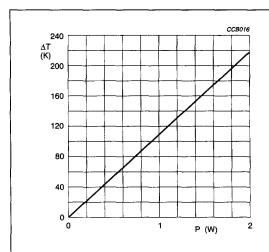
Ø0.6 mm FeCu-leads.

Minimum distance from resistor body to PCB = 1 mm.

PR02

Fig.25 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

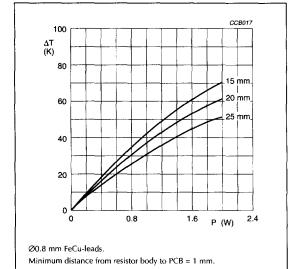
PR01/02/03



Ø0.8 mm FeCu-leads.

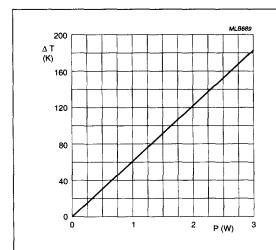
PR02

Fig.26 Hot-spot temperature rise (ΔT) as a function of dissipated power.



PR02

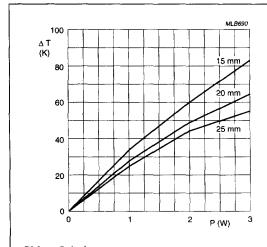
Fig.27 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø0.8 mm Cu-leads.

PR03

Fig.28 Hot-spot temperature rise (ΔT) as a function of dissipated power.



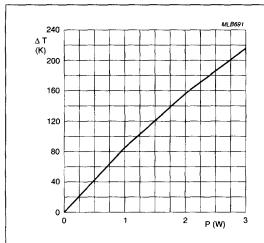
Ø0.8 mm Cu-leads.

Minimum distance from resistor body to PCB = 1 mm.

PR03

Fig.29 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

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Ø0.6 mm FeCu-leads.

PR03

Fig. 30 Hot-spot temperature rise (ΔT) as a function of dissipated power.

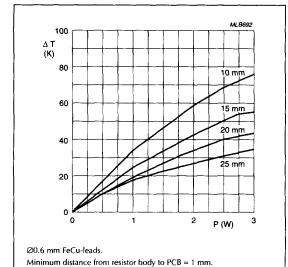
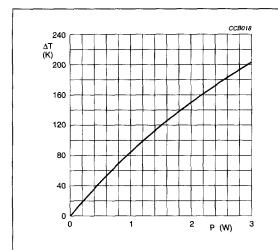


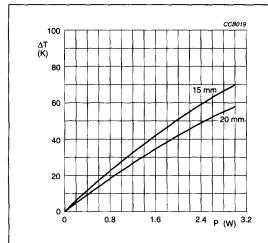
Fig.31 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø0.8 mm FeCu-leads.

PR03

Fig.32 Hot-spot temperature rise (ΔT) as a function of dissipated power.

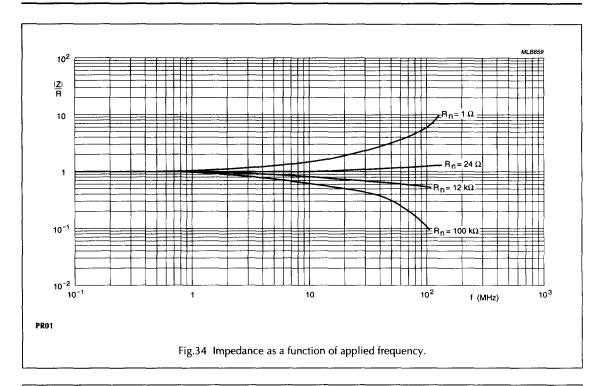


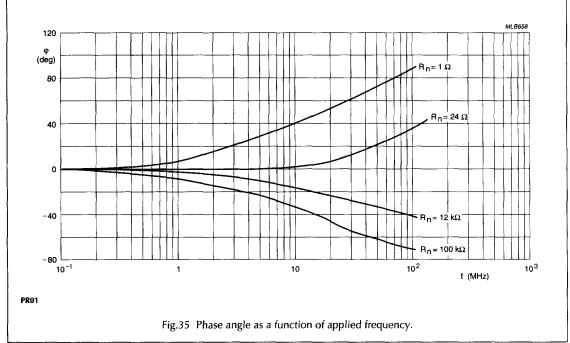
 \emptyset 0.8 mm FeCu-leads. Minimum distance from resistor body to PCB = 1 mm.

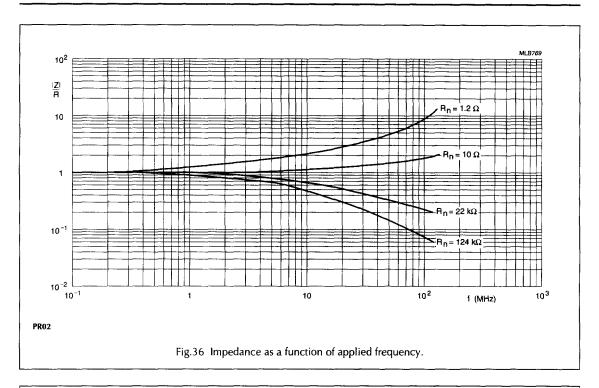
PR03

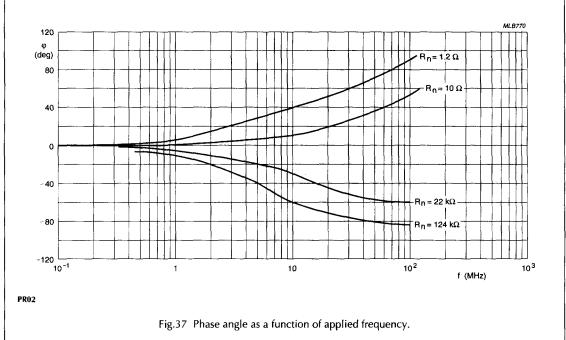
PR03

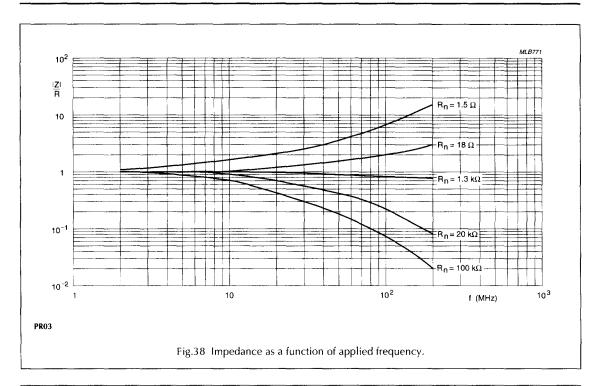
Fig.33 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

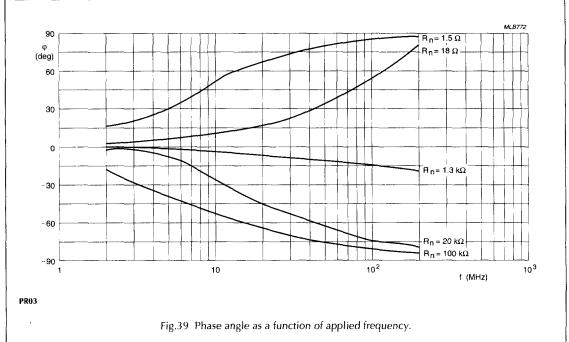












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MECHANICAL DATA

Mass per 100 units

TYPE	LEAD MATERIAL	MASS (g)
PR01	Cu	29
1	FeCu	29
PR02	Cu	63
	FeCu	45
PR03	Cu	110
L	FeCu	100

Mounting

The resistors are suitable for processing on automatic insertion equipment and cutting and bending machines.

Marking

The nominal resistance and tolerance are marked on the resistor using four coloured bands in accordance with IEC publication 60062, "Colour codes for fixed resistors".

Outlines

The length of the body (L_1) is measured by inserting the leads into holes of two identical gauge plates and moving these plates parallel to each other until the resistor body is clamped without deformation

("IEC publication 60294").

Mounting pitch

TVDT	LEAD CTVIE	PIT	СН
TYPE	LEAD STYLE	mm	e
PR01	straight leads	12.5(1)	5 ⁽¹⁾
	radial taped	4.8	2
	cropped and formed	17.8	7
	double kink large pitch	17.8	7
	double kink small pitch	12.5	5
PR02	straight leads	15.0(1)	6(1)
	radial taped	4.8	2
	cropped and formed	17.8	7
	double kink large pitch	17.8	7
	double kink small pitch	15.0	6
PR03	straight leads	23.0(1)	9(1)
	cropped and formed	25.4	10
	double kink large pitch	25.4	10
	double kink small pitch	20.0	8

Note

1. Recommended minimum value.

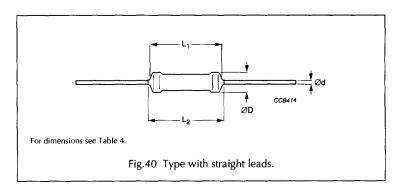


Table 4 Straight lead type and relevant physical dimensions: see Fig.40

ТҮРЕ	ØD MAX. (mm)	L ₁ MAX. (mm)	L ₂ MAX. (mm)	Ød (mm)
PR01	2.5	6.5	8.5	0.58 ±0.05
DDOO	2.0	10.0	13.0	0.8 ±0.03
PR02	3.9	3.9	12.0	0.58 ±0.05
DDO	F 2	16.7	19.5	0.8 ±0.03
PR03	5.2	16.7	19.5	0.58 ±0.05

BCcomponents Product specification

Professional power metal film resistors

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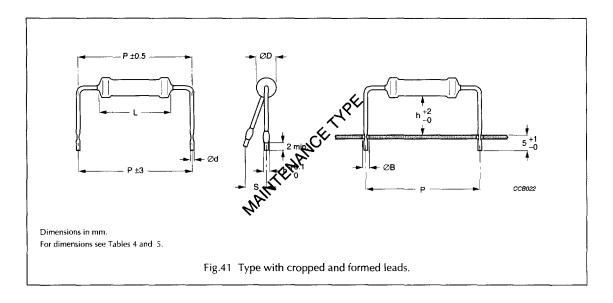


Table 5 Cropped and formed lead type and relevant physical dimensions; see Fig.41

TYPE	LEAD STYLE	Ød (mm)	b (mm)	h (mm)	P (mm)	S MAX. (mm)	ØB MAX. (mm)
PR01		0.6 ±0.05	1.1	8	17.8	2	1.0
		0.8 ±0.03	1.3	8		2	1.2
PR02		0.8 ±0.03	1.3	15	17.8	3	1.2
	cropped and formed; note 1	0.6 ±0.05	1.1	8		2	1.0
	note i	0.8 ±0.03	1.3	8		2	1.2
PR03		0.8 ±0.03	1.3	15	25.4	3	1.2
		0.6 ±0.05	1.1	8		2	1.0

Note

1. Can be replaced by double kinked versions; see Fig.42.

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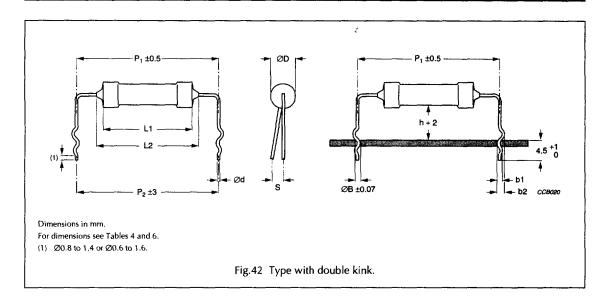


 Table 6
 Double kink lead type and relevant physical dimensions; see Fig.42

TYPE	LEAD STYLE	Ød (mm)	b1 (mm)	b2 (mm)	h (mm)	P ₁ (mm)	P ₂ (mm)	S MAX. (mm)	ØB (mm)
PR01	double kink large pitch	0.58 ±0.05	1.10 +0.25/–0.20	1.45 +0.25/-0.20	8	17.8	17.8	2	0.8
PKUI	double kink small pitch	0.58 ±0.05	1.10 +0.25/–0.20	1.45 +0.25/ - 0.20	8	12.5	12.5	2	0.8
PR02	double kink large pitch	0.58 ±0.05	1.10 +0.25/ - 0.20	1.45 +0.25/–0.20	8	17.8	17.8	2	0.8
PKU2	double kink small pitch	0.8 ±0.03	1.30 +0.25/-0.20	1.65 +0.25/–0.20	8	15.0	15.0	2	1.0
DD02	double kink large pitch	0.58 ±0.05	1.10 +0.25/-0.20	1.45 +0.25/–0.20	8	25.4	25.4	2	0.8
PR03	double kink small pitch	0.8 ±0.03	1.30 +0.25/–0.20	2.15 +0.25/–0.20	8	22.0	20.0	2	1.0

BCcomponents Product specification

Professional power metal film resistors

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TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with the schedule of "IEC publication 60115-1", category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days). The testing also covers the requirements specified by EIA and EIAJ.

The tests are carried out in accordance with IEC publication 60068-2, "Recommended basic climatic and mechanical robustness testing procedure for electronic components" and under standard atmospheric conditions according to "IEC 60068-1", subclause 5.3.

In Table 7 the tests and requirements are listed with reference to the relevant clauses of "IEC publications 60115-1 and 60068-2"; a short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

Table 7 Test procedures and requirements

IEC 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS					
Tests in ac	Tests in accordance with the schedule of IEC publication 60115-1								
4.4.1		visual examination		no holes; clean surface; no damage					
4.4.2		dimensions (outline)	gauge (mm)	see Tables 4, 5 and 6					
4.5		resistance	applied voltage (+0/-10%): $R < 10 \ \Omega: 0.1 \ V$ $10 \ \Omega \le R < 100 \ \Omega: 0.3 \ V$ $100 \ \Omega \le R < 1 \ k\Omega: 1 \ V$ $1 \ k\Omega \le R < 10 \ k\Omega: 3 \ V$ $10 \ k\Omega \le R < 100 \ k\Omega: 10 \ V$ $100 \ k\Omega \le R < 100 \ k\Omega: 25 \ V$ $R = 1 \ M\Omega: 50 \ V$	R – R _{nom} ; max. ±5%					
4.18	20 (Tb)	resistance to soldering heat	thermal shock: 3 s; 350 °C; 6 mm from body	Δ R/R max.: \pm 1% + 0.05 Ω					
4.29	45 (Xa)	component solvent resistance	isopropyl alcohol or H ₂ O followed by brushing in accordance with "MIL 202 F"	no visual damage					
4.17	20 (Ta)	solderability	2 s; 235 °C	good tinning; no damage					
4.7		voltage proof on insulation	maximum voltage 500 V (RMS) during 1 minute; metal block method	no breakdown or flashover					

PR01/02/03

IEC 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
4.16	21 (U)	robustness of terminations:		
4.16.2	21 (Ua1) 21 (Ub)	tensile all samples bending half number of samples	load 10 N; 10 s load 5 N; 4 × 90°	number of failures: $<1 \times 10^{-6}$ number of failures: $<1 \times 10^{-6}$
4.16.4	21 (Uc)	torsion other half of samples	3 × 360° in opposite directions	no damage Δ R/R max.: ±0.5% + 0.05 Ω
4.20	29 (Eb)	bump	3×1500 bumps in three directions; 40 g	no damage Δ R/R max.: ±0.5% + 0.05 Ω
4.22	6 (Fc)	vibration	frequency 10 to 500 Hz; displacement 1.5 mm or acceleration 10 g; three directions; total 6 hours $(3 \times 2 \text{ hours})$	no damage Δ R/R max.: ±0.5% + 0.05 Ω
4.19	14 (Na)	rapid change of temperature	30 minutes at LCT and 30 minutes at UCT; 5 cycles	no visual damage PR01: ΔR/R max.: ±1% + 0.05 Ω PR02: ΔR/R max.: ±1% + 0.05 Ω PR03: ΔR/R max.: ±2% + 0.05 Ω
4.23 4.23.3	30 (Db)	climatic sequence: damp heat (accelerated) 1st cycle		
4.23.6	30 (Db)	damp heat (accelerated) remaining cycles	6 days; 55 ℃; 95 to 98% RH	R_{ins} min.: 10^3 M Ω Δ R/R max.: $\pm 3\% + 0.1$ Ω
4.24.2	3 (Ca)	damp heat (steady state) (IEC)	56 days; 40 °C; 90 to 95% RH; loaded with 0.01 P_n (IEC steps: 4 to 100 V)	R_{ins} min.: 1 000 MΩ Δ R/R max.: ±3% + 0.1 Ω
4.25.1		endurance (at 70 °C)	1000 hours; loaded with P _n or V _{max} ; 1.5 hours on and 0.5 hours off	Δ R/R max.: ±5% + 0.1 Ω
4.8.4.2		temperature coefficient	at 20/LCT/20 °C and 20/UCT/20 °C (TC × 10 ⁻⁶ /K)	≤±250
Other test	s in accorda	ance with IEC 60115 c	lauses and IEC 60068 test method	
4.17	20 (Tb)	solderability (after ageing)	8 hours steam or 16 hours 155 °C; leads immersed 6 mm for 2 \pm 0.5 s in a solder bath at 235 \pm 5 °C	good tinning (≥95% covered); no damage
4.6.1.1		insulation resistance	maximum voltage (DC) after 1 minute; metal block method	R_{ins} min.: 10^4 M Ω
see 2 nd an to IEC 600 Jan. '87		pulse load		see Figs 5, 6, 7, 8, 9 and 10